

at least one reference mark located on a surface of the electronic component and serving as a reference for the arrangement positions of said electrical connecting portions.

27. An electronic component as claimed in claim 26, wherein said at least one reference mark comprises a pair of reference marks positioned symmetrically with respect to a center point of said electrical connecting surface, wherein said electrical connecting portions are disposed in an array that surrounds said reference marks.

28. An electronic component as claimed in claim 26, wherein said at least one reference mark comprises a plurality of reference marks that are positioned symmetrically with respect to a center point of said electrical connecting surface, wherein said reference marks are located in a central portion of said electrical connecting surface, and said electrical connecting portions are disposed around said reference marks.

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29.(Amended) An electronic component as claimed in claim 26, wherein said reference mark is provided on a side of said electrical connecting surface that is adapted to confront a mounting position of the printed board.

30. An electronic component as claimed in claim 29, wherein said reference mark comprises a projection or a printed symbol.

31. An electronic component as claimed in claim 29, wherein said reference mark includes coded information indicative of said electronic component.

32. An electronic component as claimed in claim 31, wherein the coded information of said reference mark is information concerned with a state in which the electrical connecting portions are formed.

33.(amended) An electronic component as claimed in claim 26, wherein said reference mark is located in a corner portion of an opposite side of the electronic component relative to said electrical connecting portions.

34. An electronic component as claimed in claim 26, wherein said reference mark is formed on said electrical connecting surface simultaneously with said electrical connecting portions.

35. An electronic component as claimed in claim 26, wherein said electrical connecting portions are solder bumps.

36. An electronic component as claimed in claim 26, wherein said electrical connecting portions are lands.